

Description

The series of devices uses **Super Trench II** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

General Features

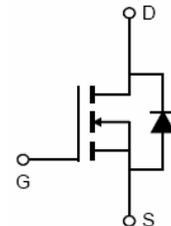
- $V_{DS} = 120V, I_D = 190A$
 $R_{DS(ON)} = 3.0m\Omega$, typical (TO-220) @ $V_{GS} = 10V$
 $R_{DS(ON)} = 2.8m\Omega$, typical (TO-263) @ $V_{GS} = 10V$
- Excellent gate charge x $R_{DS(on)}$ product (FOM)
- Very low on-resistance $R_{DS(on)}$
- 175 °C operating temperature
- Pb-free lead plating



TO-220C



TO-263



Schematic Diagram

Package Marking and Ordering Information

| Device Marking | Device | Device Package | Reel Size | Tape width | Quantity |
|----------------|-----------|----------------|-----------|------------|----------|
| VST12N030-TC | VST12N030 | TO-220C | - | - | - |
| VST12N030-T3 | VST12N030 | TO-263 | - | - | - |

Absolute Maximum Ratings ($T_C = 25^\circ\text{C}$ unless otherwise noted)

| Parameter | Symbol | Limit | Unit |
|--|--------------------------|------------|------|
| Drain-Source Voltage | V_{DS} | 120 | V |
| Gate-Source Voltage | V_{GS} | ± 20 | V |
| Drain Current-Continuous | I_D | 190 | A |
| Drain Current-Continuous ($T_C = 100^\circ\text{C}$) | $I_D(100^\circ\text{C})$ | 135 | A |
| Pulsed Drain Current | I_{DM} | 760 | A |
| Maximum Power Dissipation | P_D | 300 | W |
| Derating factor | | 2 | W/°C |
| Single pulse avalanche energy ^(Note 5) | E_{AS} | 2300 | mJ |
| Operating Junction and Storage Temperature Range | T_J, T_{STG} | -55 To 175 | °C |

Thermal Characteristic

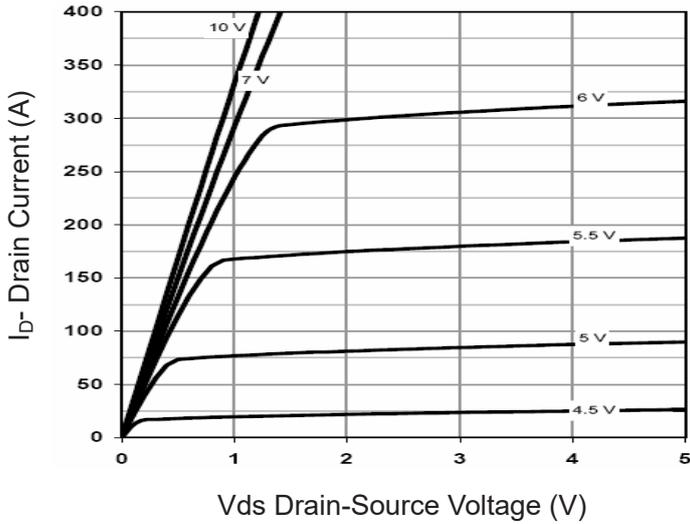
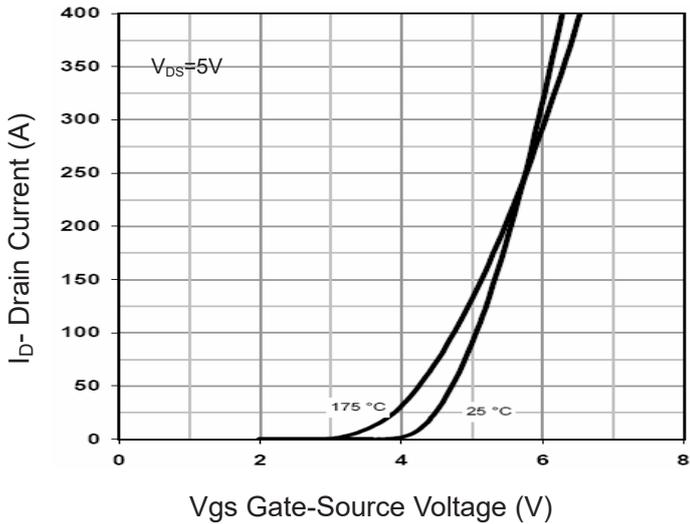
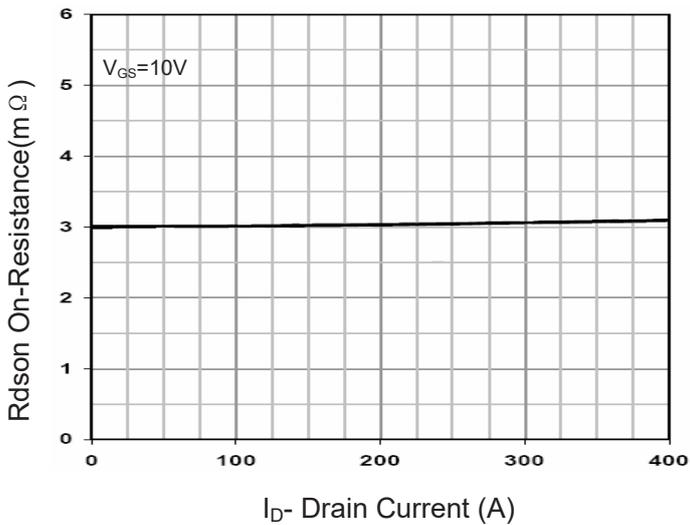
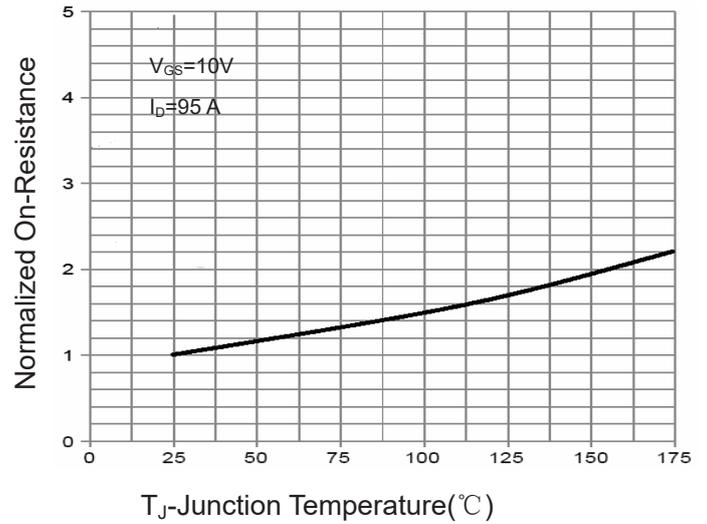
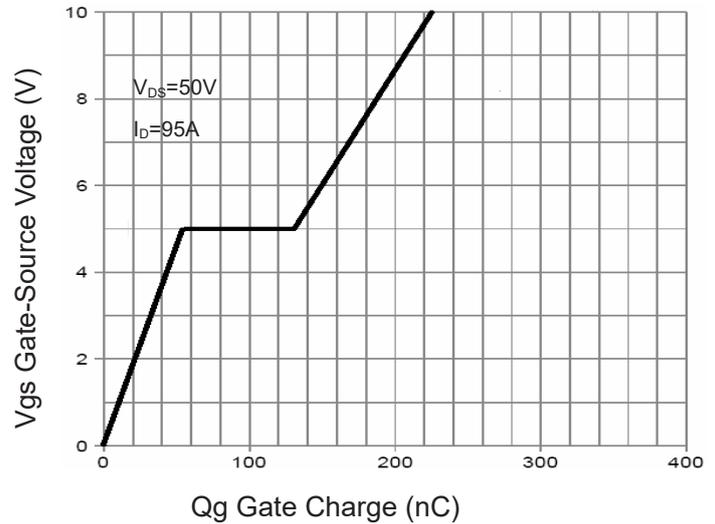
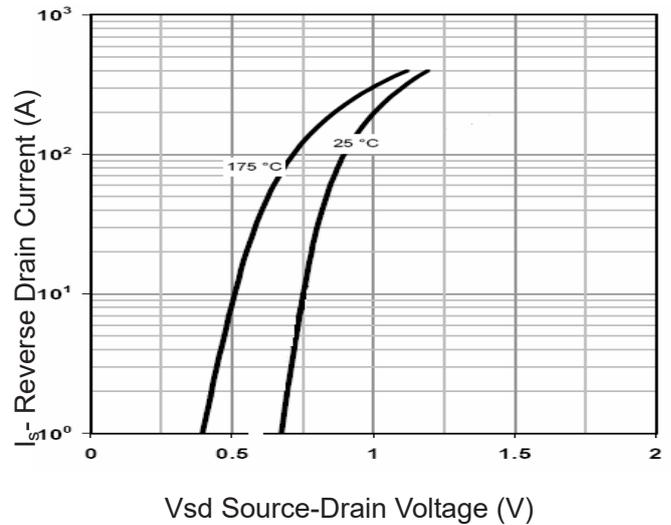
| | | | |
|--|-----------------|-----|------|
| Thermal Resistance, Junction-to-Case ^(Note 2) | $R_{\theta JC}$ | 0.5 | °C/W |
|--|-----------------|-----|------|

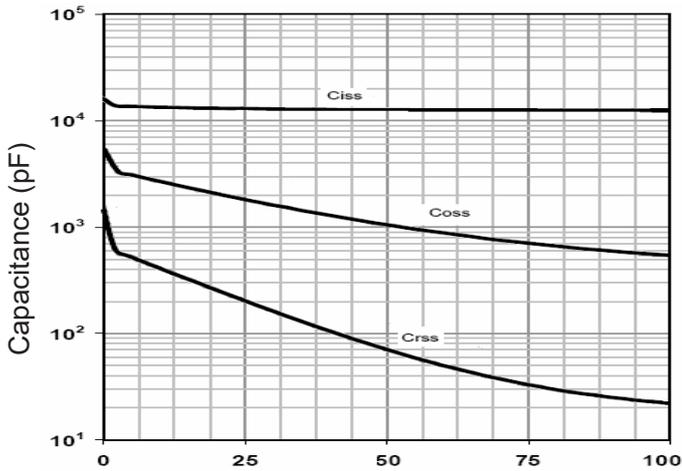
Electrical Characteristics (T_C=25°C unless otherwise noted)

| Parameter | Symbol | Condition | Min | Typ | Max | Unit | |
|---|---------------------|---|--------|-------|------|------|----|
| Off Characteristics | | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V, I _D =250μA | 120 | | - | V | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =120V, V _{GS} =0V | - | - | 1 | μA | |
| Gate-Body Leakage Current | I _{GSS} | V _{GS} =±20V, V _{DS} =0V | - | - | ±100 | nA | |
| On Characteristics (Note 3) | | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | V _{DS} =V _{GS} , I _D =250μA | 2.0 | 3.0 | 4.0 | V | |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} =10V, I _D =95A | TO-220 | - | 3.0 | 3.5 | mΩ |
| | | | TO-263 | | 2.8 | 3.5 | mΩ |
| Forward Transconductance | g _{FS} | V _{DS} =5V, I _D =95A | | 90 | - | S | |
| Dynamic Characteristics (Note 4) | | | | | | | |
| Input Capacitance | C _{iss} | V _{DS} =60V, V _{GS} =0V, F=1.0MHz | - | 12700 | - | PF | |
| Output Capacitance | C _{oss} | | - | 870 | - | PF | |
| Reverse Transfer Capacitance | C _{rss} | | - | 48 | - | PF | |
| Switching Characteristics (Note 4) | | | | | | | |
| Turn-on Delay Time | t _{d(on)} | V _{DD} =60V, I _D =95A V _{GS} =10V, R _G =1.6Ω | - | 34 | - | nS | |
| Turn-on Rise Time | t _r | | - | 27 | - | nS | |
| Turn-Off Delay Time | t _{d(off)} | | - | 78 | - | nS | |
| Turn-Off Fall Time | t _f | | - | 30 | - | nS | |
| Total Gate Charge | Q _g | V _{DS} =50V, I _D =95A, V _{GS} =10V | - | 213 | - | nC | |
| Gate-Source Charge | Q _{gs} | | - | 58 | | nC | |
| Gate-Drain Charge | Q _{gd} | | - | 58 | | nC | |
| Drain-Source Diode Characteristics | | | | | | | |
| Diode Forward Voltage (Note 3) | V _{SD} | V _{GS} =0V, I _S =95A | - | | 1.2 | V | |
| Diode Forward Current (Note 2) | I _S | | - | - | 190 | A | |
| Reverse Recovery Time | t _{rr} | T _J = 25°C, I _F = 100A | - | 101 | - | nS | |
| Reverse Recovery Charge | Q _{rr} | di/dt = 100A/μs (Note 3) | - | 280 | - | nC | |

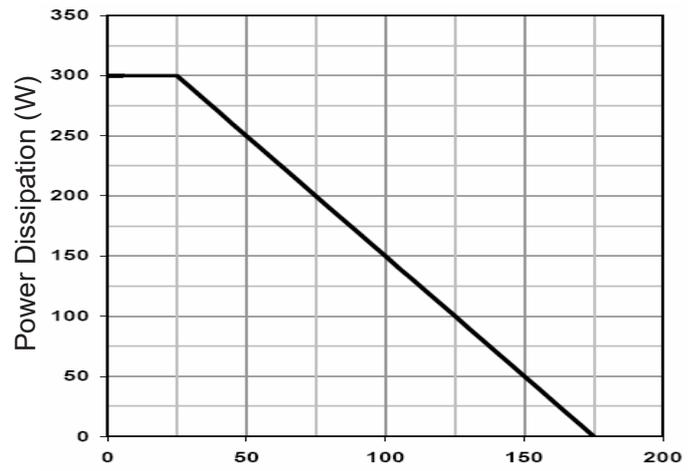
Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production
5. EAS condition : T_J=25°C, V_{DD}=60V, V_G=10V, L=0.5mH, R_G=25Ω

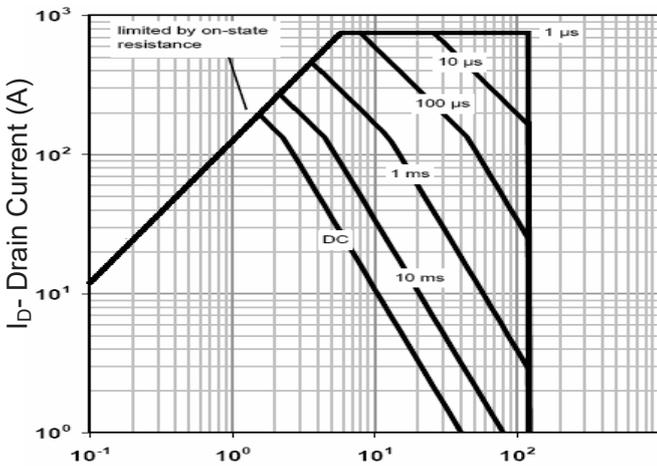
Typical Electrical and Thermal Characteristics

Figure 1 Output Characteristics

Figure 2 Transfer Characteristics

Figure 3 Rdson- Drain Current

Figure 4 Rdson-Junction Temperature

Figure 5 Gate Charge

Figure 6 Source- Drain Diode Forward



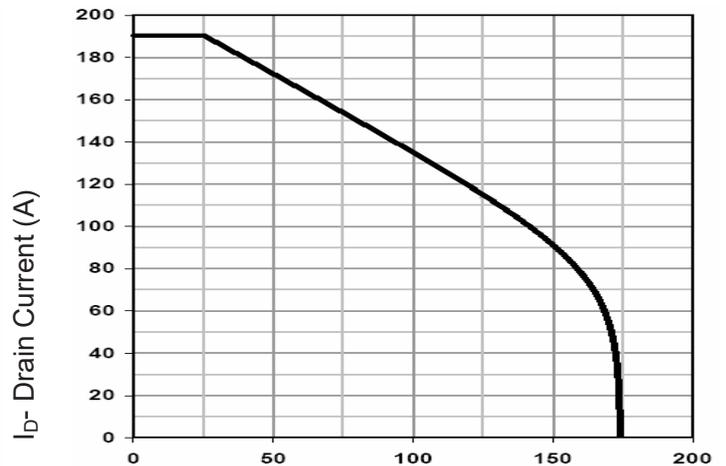
Vds Drain-Source Voltage (V)
Figure 7 Capacitance vs Vds



T_J-Junction Temperature(°C)
Figure 9 Power De-rating



Vds Drain-Source Voltage (V)
Figure 8 Safe Operation Area



T_J-Junction Temperature (°C)
Figure 10 Current De-rating

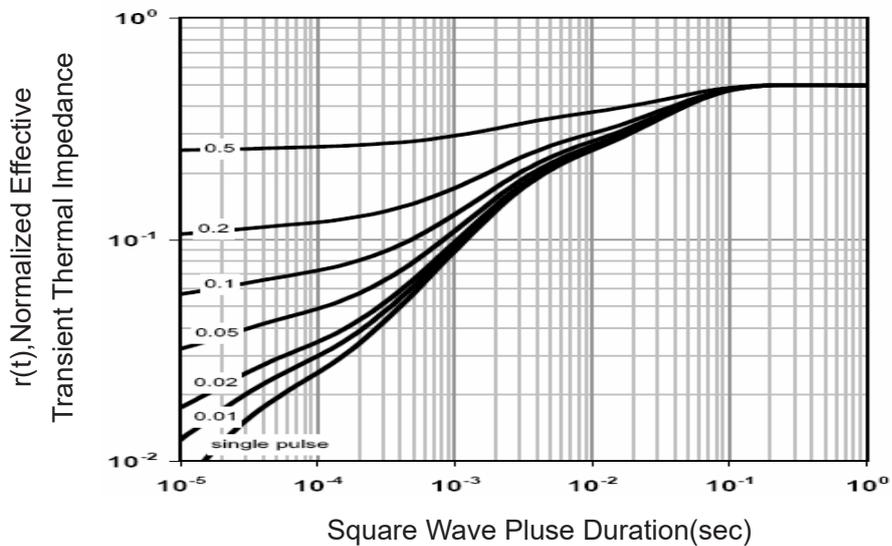


Figure 11 Normalized Maximum Transient Thermal Impedance